1.2A, 23V, 1.4MHz Step-Down Converter

Halogen Free

General Description

The FP6190 is a buck regulator with a built-in internal power MOSFET. It can provide 1.2A continuous output current over a wide input supply range with excellent load and line regulation. Current mode operation provides fast transient response and eases loop stabilization. This device includes cycle-by-cycle current limiting and thermal shutdown protection. Internal soft-start reduces the stress on the input source at power-on. The FP6190 requires a minimum number of readily available external components to complete a 1.2A buck regulator solution.

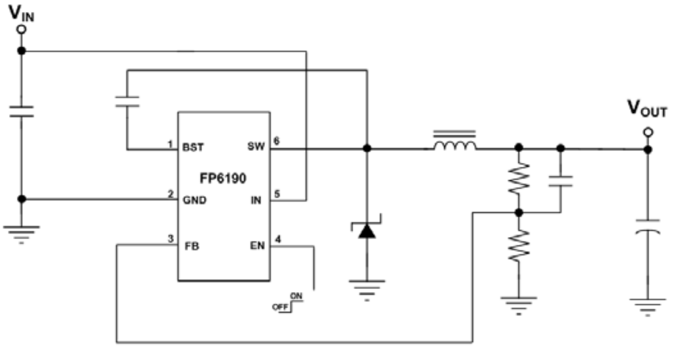
Features

- 1.2A Output Current
- 0.35Ω Internal High Side Power MOSFET Switch
- Stable with Low ESR Output Ceramic Capacitors
- Up to 92% Efficiency
- 0.1μA Shutdown Mode Current
- Fixed 1.4MHz Frequency
- Thermal Shutdown
- Cycle-by-Cycle Over Current Protection
- Wide 4.75 to 23V Operating Input Range
- Output Adjustable From 0.81 to 15V
- Available in TSOT23-6L / SOT23-6L Packages

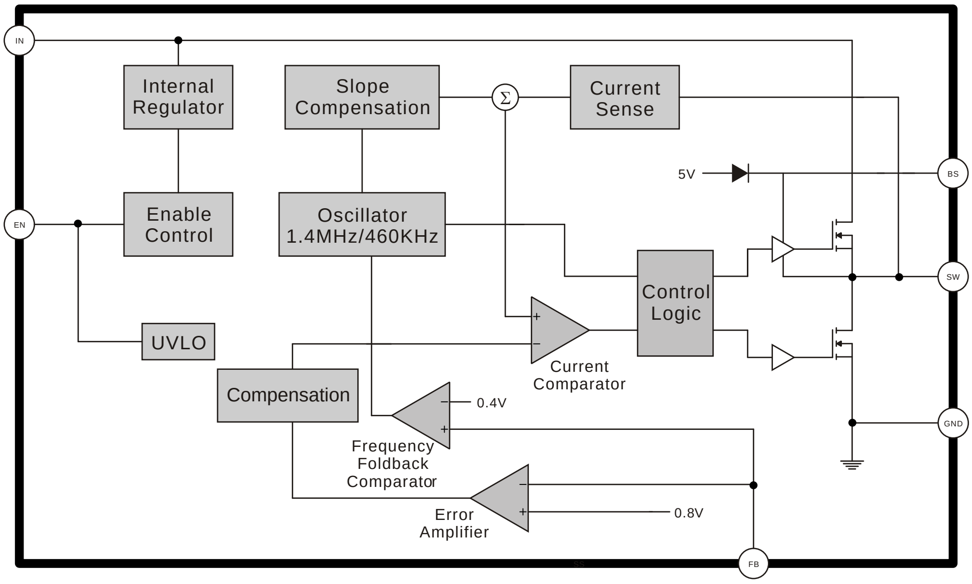
Applications

- Distributed Power Systems
- Battery Charger
- Pre-Regulator for Linear Regulators
- DSL Modems

Typical Application Circuit

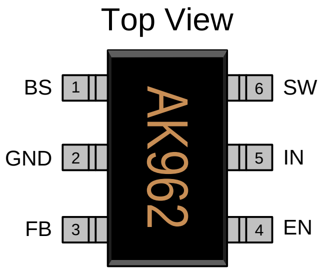


Function Block Diagram



Pin Descriptions

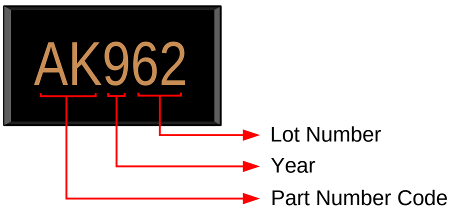
TSOT23-6L / SOT23-6L



Name	No.	I / O	Description
BS	1	P	Bootstrap
GND	2	P	IC Ground
FB	3	I	Error Amplifier Compensation Output
EN	4	I	Enable / UVLO
IN	5	P	Supply Voltage
SW	6	O	Switch

Marking Information

TSOT23-6L / SOT23-6L



Lot Number: Wafer lot number's last two digits

For Example: 132386TB → 86

Year: Production year's last digit

Part Number Code: Part number identification code for this product. It should be always "AK".

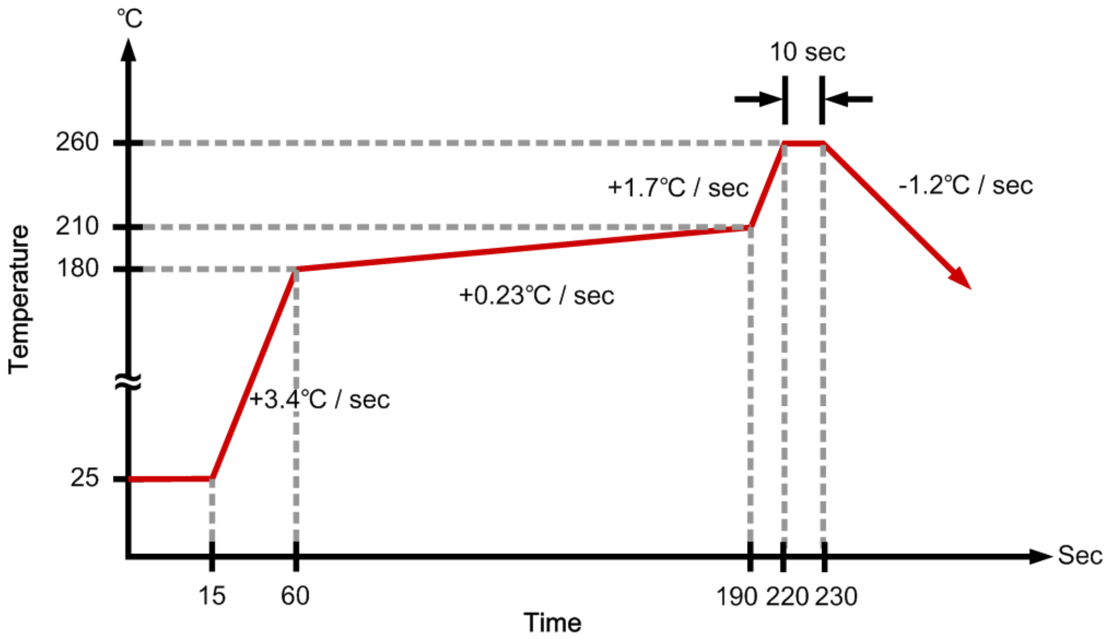
Ordering Information

Part Number	Operating Temperature	Package	MOQ	Description
FP6190hR-G1	-40°C ~ +85°C	TSOT23-6L	3000EA	Tape & Reel
FP6190LR-G1	-40°C ~ +85°C	SOT23-6L	3000EA	Tape & Reel

Absolute Maximum Ratings

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Supply Voltage	V_{IN}		-0.3		26	V
Supply Voltage	V_{sw}		-1		V_{IN} +0.3	V
Bootstrap Voltage	V_{BS}		V_{sw} -0.3		V_{sw} +6	V
All Other Pins			-0.3		6	V
Junction Temperature	T_J				+150	℃
Storage Temperature	T_S		-65		+150	℃
Thermal Resistance	θ_{JA}	TSOT23-6L			220	℃ / W
		SOT23-6L				
	θ_{JC}	TSOT23-6L			110	℃ / W
		SOT23-6L				
Operating Temperature			-40		+85	℃
Lead Temperature (soldering, 10 sec)					+260	℃

Suggested IR Re-flow Soldering Curve



Recommended Operating Conditions

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Supply Voltage	V_{IN}		4.75		23	V
Operating Temperature		Ambient Temperature	-40		85	°C

DC Electrical Characteristics (V_{IN}=12V, T_A= 25°C, unless otherwise noted)

Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit
Standby Current	I_{SB}	V_{EN}=2V, V_{FB}=1.0V		0.8	1.2	mA
Shutdown Supply Current	I_{ST}	V_{EN}=0		0.1	1.0	μA
Feedback Voltage	V_{FB}	4.5V<V_{IN}<24V	0.78	0.8	0.82	V
Feedback Current	I_{FB}	V_{FB}=0.8V		0.1		μA
Switch ON Resistance	R_{ON}			0.35		Ω
Switch Leakage Current	I_{IL}	V_{EN}=0, V_{SW}=0V			10	μA
Current Limit	I_{CL}			1.5		A
Oscillation Frequency	f_{OSC}		1.2	1.4	1.7	MHz
Short Circuit Oscillation Frequency	f_{SC}	V_{FB}=0V		460		KHz
Maximum Duty Cycle	D_{MAX}	V_{FB}=0.6V		87		%
Minimum On Time	T_{ON}	V_{FB}=1.5V		100		ns
Under Voltage Lockout Threshold	V_{UVLO}	V_{EN} Rising	2.5	2.8	3.1	V
Under Voltage Lockout Threshold Hysteresis	V_{HYS}			150		mV
EN Input Low Voltage					0.4	V
EN Input High Voltage			1.2			V
EN Input Current	I_{EN}	V_{EN}=2V		2.1		μA
		V_{EN}=0V		0.1		
Thermal Shutdown	T_{TS}			150		°C

Function Description

The FP6190 is a current-mode step-down DC / DC converter that provides excellent transient response with no extra external compensation components. It regulates input voltages from 4.5V to 24V down to an output voltage as low as 0.81V with maximum 1.2A load current. and operates at a high 1.4MHz operating frequency to ensure a compact, high-efficiency design with excellent AC and DC performance.The output voltage is measured at FB pin through a resistive voltage divider and amplified by the internal error amplifier. The converter uses an internal n-channel MOSFET switch to step-down the input voltage to the regulated output voltage. Since the n-channel MOSFET requires a gate voltage greater than the input voltage, a boost capacitor connected between SW and BS drives the MOS gate. The capacitor is internally charged while the MOS switch is off.

Output Voltage (V_{OUT})

The output voltage is set using a resistive voltage divider from the output voltage to FB. The voltage divider divides the output voltage down by the ratio:

$$V_{FB} = V_{OUT} \times \frac{R_2}{R_1 + R_2}$$

Thus the output voltage is:

$$V_{OUT} = V_{FB} \times \frac{R_1 + R_2}{R_2}$$

Enable Mode / Shutdown Mode

Drive EN Pin to ground to shut down the FP6190. Shutdown mode forces the internal power MOSFET off, turns off all internal circuitry, and reduces the V_{IN} supply current to 0.1µA (typ.). The EN Pin rising threshold is 1.0V (typ.). Before any operation begins, the voltage at EN pin must exceed 1.0V (typ.).

The EN pin input has 100mV hysteresis.

Boost High-Side Gate Drive (BST)

Since the MOSFET requires a gate voltage greater than the input voltage, user should connect a flying bootstrap capacitor between SW and BS pin to provide the gate-drive voltage to the high-side n-channel MOSFET switch. The capacitor is charged by the internally regulator periodically when SW pin is pulled to ground. During startup, an internal low-side switch pulls SW to ground and charges the BST capacitor to internally regulator output voltage. Once the BST capacitor is charged, the internal low-side switch is turned off and the BST capacitor provides the necessary enhancement voltage to turn on the high-side switch.

Thermal Shutdown Protection

The FP6190 features integrated thermal shutdown protection. Thermal shutdown protection limits allowable power dissipation (P_D) in the device and protects the device in the event of a fault condition. When the IC junction temperature exceeds +150°C, an internal thermal sensor signals the shutdown logic to turn off the internal power MOSFET and allow the IC cooling down. The thermal sensor turns the internal power MOSFET back on after the IC junction temperature cools down to + 110°C, resulting in a pulsed output under continuous thermal overload conditions.

Application Information

Input Capacitor Selection

The input current to the step-down converter is discontinuous, therefore a capacitor is required to supply the AC current to the step-down converter while maintaining the DC input voltage. Use low ESR capacitors for the best performance. Ceramic capacitors are preferred, but tantalum or low-ESR electrolytic capacitors may also suffice.

The input capacitor can be electrolytic, tantalum or ceramic. When electrolytic or tantalum capacitors are used, a small, high quality 0.1μF ceramic capacitor should be placed beside the IC as possible.

When using ceramic capacitors, make sure that they have enough capacitance to provide sufficient charge to prevent excessive voltage ripple at converter input. The input voltage ripple can be estimated by

$$C_{IN} = \frac{I_O}{f \times \Delta V_{IN}} \times D(1-D)$$

Inductor Selection

The inductor is required to supply constant current to the output load while being driven by the switched input voltage. A larger value inductor will result in less ripple current that will result in lower output ripple voltage. However, the larger value inductor will have a larger physical size, higher series resistance, and/or lower saturation current. A good rule for determining the inductance to use is to allow the peak-to-peak ripple current in the inductor to be approximately 30% of the maximum switch current. Also, make sure that the peak inductor current is below the maximum switch current limit. The inductance value can be calculated by

$$L = \frac{V_O + V_D}{I_O \gamma f} \times (1-D)$$

Where r is the ripple current ratio

RMS current in inductor $I_{Lrms} = I_O \sqrt{1 + \frac{\gamma^2}{12}}$

Output Capacitor Selection

The output capacitor is required to maintain the DC output voltage. Ceramic, tantalum, or low ESR electrolytic capacitors are recommended. Low ESR capacitors are preferred to keep the output voltage ripple low. The output voltage ripple can be estimated by:

$$\Delta V_{OUT} = \frac{V_{OUT} \times (V_{IN} - V_{OUT})}{f \times L \times V_{IN}} \times \left(ESR + \frac{1}{8 \times f \times C_{OUT}} \right)$$

In the case of ceramic capacitors, the output ripple is dominated by the capacitance value because of its low ESR. In the case of tantalum or electrolytic capacitors, the capacitor high ESR dominates the output ripple. Followings are equations for determining appropriate capacitor parameters.

Ⅰ. Ceramic capacitors: choose capacitance value

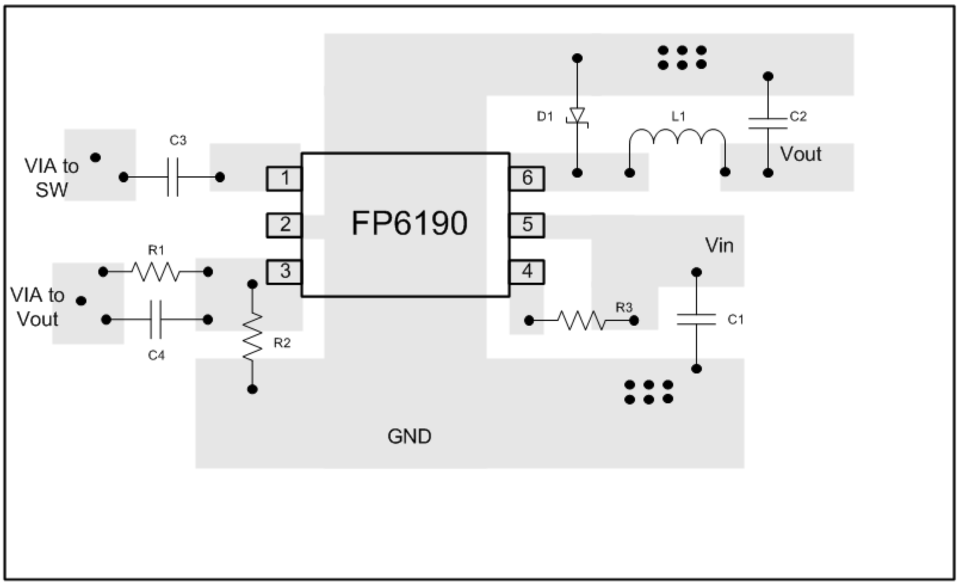
$$C_{OUT} = \frac{V_{OUT}}{8 \times f^2 \times L \times \Delta V_{OUT}} \times \left(1 - \frac{V_{OUT}}{V_{IN}} \right)$$

Ⅱ. Tantalum or electrolytic capacitors: choose capacitor with ESR value

$$ESR = \frac{\Delta V_{OUT} \times f \times L \times V_{IN}}{V_{OUT} \times (V_{IN} - V_{OUT})}$$

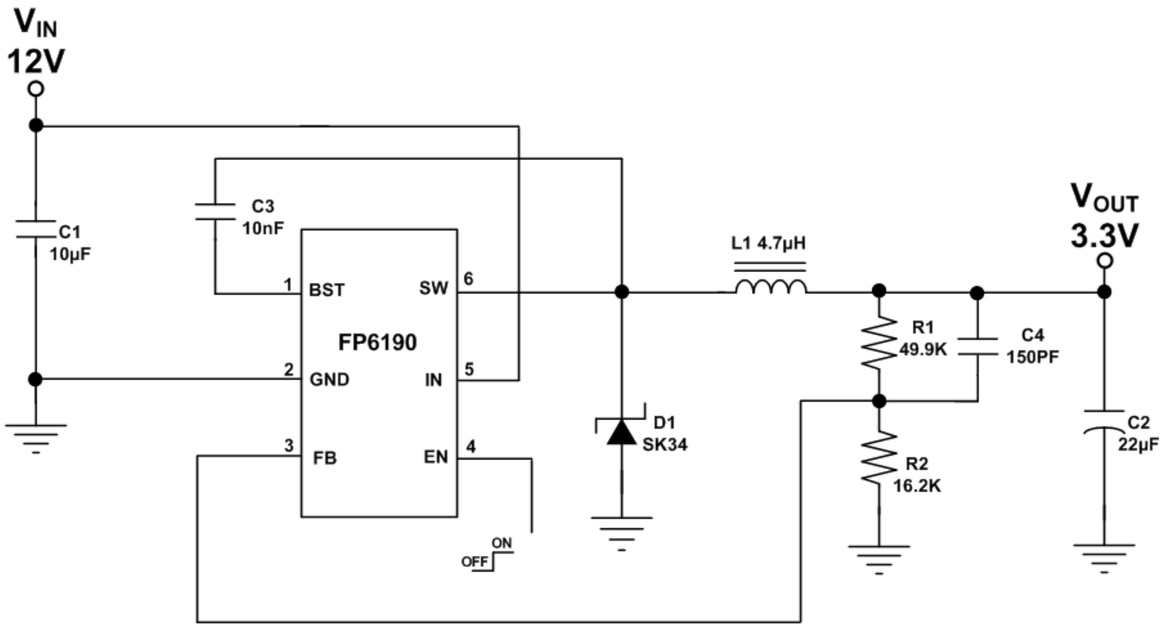
PC Board Layout Checklist

1. The power traces, consisting of the GND, SW and V_{IN} traces, should be kept short, direct and wide.
2. Place C_{IN} near IN pin as closely as possible to maintain input voltage steady and filter out the pulsing input current.
3. The resistive divider R_1 and R_2 must be connected directly to FB pin as closely as possible.
4. FB is a sensitive node. Please keep it away from switching node SW. A good approach is to route the feedback trace on another layer and have a ground plane between the top and feedback trace routing layer. This reduces EMI radiation on to the DC-DC converter's own voltage feedback trace.



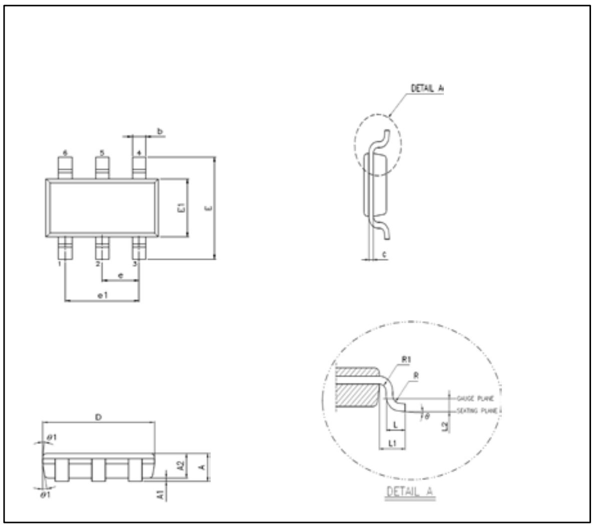
Suggested Layout

Typical Application



Package Outline

TSOT23-6L



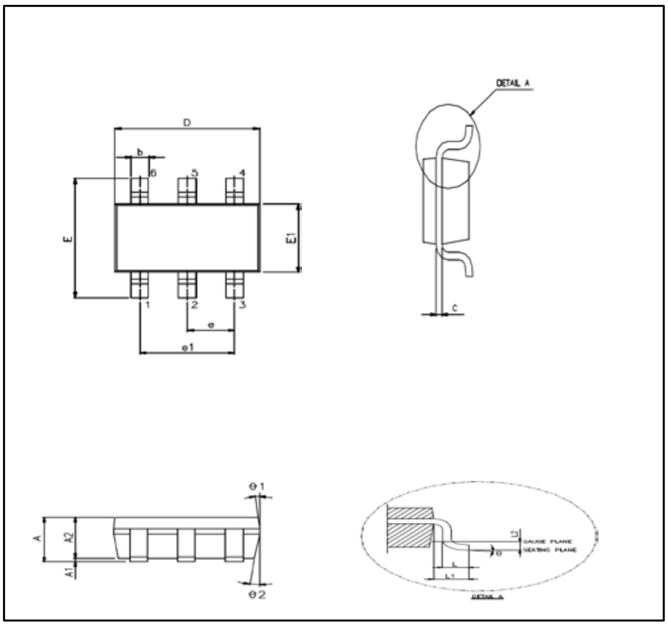
Unit: mm

Symbols	Min. (mm)	Max. (mm)
A	0.750	0.800
A1	0.000	0.050
A2	0.700	0.775
b	0.350	0.500
c	0.100	0.200
D	2.800	3.000
E	2.600	3.000
E1	1.500	1.700
e	0.950 BSC	
e1	1.900 BSC	
L	0.370	0.600
L1	0.600 REF	
L2	0.250 BSC	
R	0.100	
R1	0.100	0.250
θ°	0°	8°
θ1	4°	12°

Note:

1. Dimension “D” does not include molding flash, protrusions or gate burrs.
2. Dimension “E1” does not include inter-lead flash or protrusions.

SOT23-6L



Unit: mm

Symbols	Min. (mm)	Max. (mm)
A	1.050	1.450
A1	0.050	0.150
A2	0.900	1.300
b	0.300	0.500
c	0.080	0.220
D	2.900 BSC	
E	2.800 BSC	
E1	1.600 BSC	
e	0.950 BSC	
e1	1.900 BSC	
L	0.300	0.600
L1	0.600 REF	
L2	0.250 BSC	
θ°	0°	8°
θ1°	3°	7°
θ2°	6°	15°

Note:

1. Package dimensions are in compliance with JEDEC outline: MO-178 AB.
2. Dimension “D” does not include molding flash, protrusions or gate burrs.
3. Dimension “E1” does not include inter-lead flash or protrusions.